

CONFIG 1: 20021521-00130XXLF (WITH EDGE CUT CAP)

NOTE:

1. MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, $SQ=0.40\pm0.03MM$
2. FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER $1\mu(40u")$ MIN Ni OVER ALL
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION, INFRA-RED
OR VAPOR PHASE REFLOW OVEN.
5. PRODUCT NUMBERING:
20021521 - 0 0 X XX X X LF

LEAD FREE

PLATING:

1: GOLD FLASH ALL OVER

4: $0.25\mu(10U")$ GOLD AT CONTACT8: $0.76\mu(30U")$ GOLD AT CONTACT9: $1u"$ GOLD OVER $30u"$ PdNi AT CONTACT

PACKING

T: TUBE

D: TUBE+CAP

C: REEL +CAP

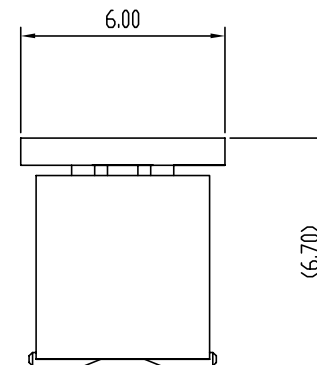
PIN COUNT




SEE TABLE 1

CONFIG

0: NORMAL

1: CONFIG 1



mat'l. code				surface ISO1302 ✓		tolerance ISO1101 ISO406		projection 		product family MINITEK							
l t r e c n n o d r				date		tolerances unless otherwise specified		title									
G						angle		MM 		1.27X1.27MM BTB HEADER							
						0.X±0.38											
						0.XX±0.25											
						0°±2'		scale 5:1		UNSHROUDED SMT.							
						dr		STERLING LIN		09/15/09		dwg no		sheet 2 of 2		size	
						engr		STERLING LIN		09/15/09				20021521		A4	
						chr		GRAY HSIEH		0915/09							
						appd		JOSEPH		09/15/09							
sheet index		revision sheet															